

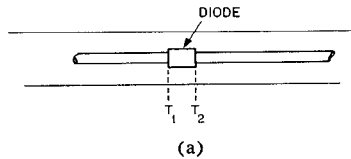
Fig. 1. Equivalent circuit for waveguide-mounted diode.

outer surface of the package is chosen as a convenient radial-line terminal surface. If unpackaged (with the semiconductor die mounted on one broad wall, and connecting wires running to the opposite broad wall), a radial-line terminal surface is chosen to lie at the surface of a hypothetical cylinder of convenient diameter that surrounds the die and connecting wires. Then, the fields external to the hypothetical surface are assigned to the waveguide and coupling network. This allows  $L_a$  and  $C_d$  to be calculated. The fields inside the surface are assigned to the diode equivalent circuit, which must be measured using the hypothetical surface as a radial-line terminal surface.

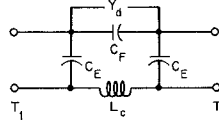
While it is normally a very good approximation to assume that the equivalent circuits of the diode mount and the packaged (real or defined) diode are completely separable it is not strictly so. First, consider the shunt-mounted diode, exemplified by a diode mounted across a waveguide, (Fig. 3(a) of Getsinger<sup>1</sup>). The circuit is given here in Fig. 1. It has equal series elements  $X_b$  on either side of the shunt connection. These elements were neglected in Getsinger<sup>1</sup> because they are small for small diameter diodes. The value for  $X_b$  depends on the construction of the diode package and internal connections to the junction. A value for  $X_b$  can be found for any given diode and waveguide by imposing equal but opposite RF voltages either side of the waveguide reference plane  $T$ , and measuring the impedance introduced when the diode is mounted at the reference plane.

A Sylvania D-5047 diode, 0.080 inch in diameter, mounted at the center of a waveguide 0.900 by 0.060 inches in cross section gave a value for  $X_b$  of  $-0.7$  ohms at about 10.8 GHz.

The measurement was made using a diode mount at the middle of a long length of waveguide terminated at each end in a small coupling aperture. The resonances occurring at those frequencies for which the structure (with diode absent) is an even number of half guide wavelengths long place equal voltages of opposite sign on either side of the terminal plane. Placing the diode in its mount causes the even numbered resonances to undergo frequency shifts from which  $X_b$  can be calculated.



(a)



(b)

Fig. 2. Diode mounted in a coaxial line.

Now consider a series-mounted diode in coaxial line, shown in Fig. 2(a). The diode length is taken to be much smaller than a wavelength, but the diode package diameter will be considered to be larger than the coaxial-line center conductor in which it is mounted.

Since the region between terminal surfaces  $T_1$  and  $T_2$ , bounded also by the outer conductor and the surface of the diode package, is small in wavelengths, we may represent the network connecting the coaxial-line terminal surfaces to the packaged-diode radial-line terminal surface by lumped elements, in accordance with the arguments of Section II, of Getsinger.<sup>1</sup>

If equal in-phase RF voltages are applied at  $T_1$  and  $T_2$ , and the admittance is measured at  $T_1$ , that admittance ( $j\omega C_E$ ) is found to result from shunt capacitance due to fringing from the end of the diode package and to direct capacitance between the internal conductors of the diode package and the outer conductor modified slightly by diode and line inductance. This measurement gives the shunt elements of an equivalent  $\pi$  network in which the packaged-diode radial-line equivalent circuit can be incorporated as part of the series arm.

Consideration of the mounting configuration indicates that the inductance  $L_c$  of the region between  $T_1$ ,  $T_2$ , the diode package surface, and the outer conductor should be in series with the packaged-diode equivalent circuit. Also, it would be expected that the electric fields in the region between the diode ends, but external to the diode package would be different than when the diode is mounted between parallel metal plates. This calls for a small corrective capacitance  $C_F$  which might be positive or negative, across the packaged-diode terminal surface. The resulting equivalent circuit is shown in Fig. 2(b) where  $Y_d$  is the total packaged-diode admittance as measured at its radial-line terminal surface.

This can be seen to be equivalent in form to the circuit of Fig. 6(b) of Getsinger<sup>1</sup> drawn for the situation where the diode package was smaller than the coaxial-line center conductor.

Sometimes it is desired to have a single terminal surface for the coaxial line at the middle of the diode, rather than terminal sur-

faces at each end. The equivalent circuit is then of the same form as in Fig. 2(b), but with values for the elements  $C_E$  and  $L_c$  adjusted for the assumption that the coaxial line now continues to the middle of the diode. Again, only  $L_c$  can be calculated; it is now the difference between the inductance external to the diode package over its length and the inductance that would exist over the same length if the diode were replaced by a continuation of the coaxial-line center conductor. For the illustration, Fig. 2(a), where the diode package diameter is greater than the center conductor diameter,  $L_c$  would have a negative value.

In these circuits, the capacitances  $C_E$  are appropriately charged against the mount, but their values depend partially on the structure of the diode internal to its package as well as on the construction of the mount. However, this contribution from the internal parts of the package is probably quite small, as was found in the waveguide situation.

It should be observed that the determination of element values for these circuits ultimately becomes a problem in measurements, because the complex mechanical configurations of diode packages or connecting straps and wires, and variations in these structures from one unit to the next make accurate analytical methods impractical.

The author hopes to subsequently describe practical measurement techniques for diodes and mounts.

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## Dual-Mode Coupler

The dual-mode coupler discussed in this correspondence is a junction in which two rectangular waveguides excite orthogonal dominant modes ( $TE_{10}$  and  $TE_{01}$ ) in a square waveguide. The coupler performs well over a relatively broad frequency band, and its simple configuration lends itself to fabrication by electroforming.

Several dual-mode couplers of various configurations have been reported previously.<sup>[1]-[12]</sup> The coupler described here is similar to that reported by LaPage<sup>[12]</sup> except that the side, or auxiliary, arm is coupled to the square guide through a resonant iris which is opposite the sloped face of the taper.

The basic design procedure was to design a linear double taper<sup>[13]</sup> for the straight-through arm and a resonant coupling iris for the side arm. The position of the side arm then was adjusted for the most desirable impedance characteristics over the design band, and it was matched with an inductive iris.

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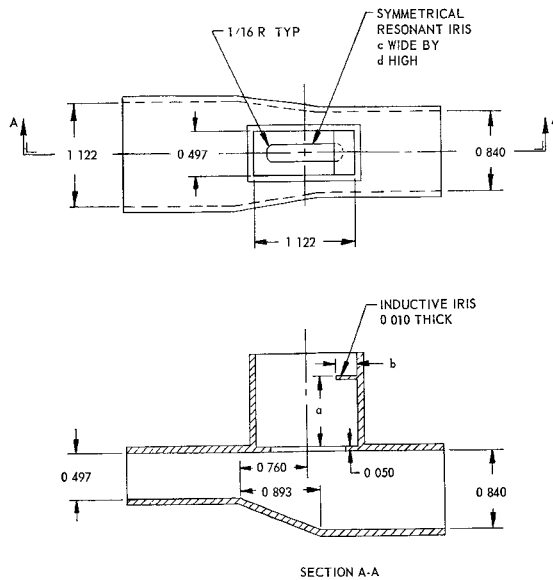


Fig. 1. Configuration of the dual-mode coupler.

TABLE I  
VALUES OF LETTER DIMENSIONS FOR THE  
COUPLER OF FIGURE 1

Dimension	Model 1 (inches)	Model 2 (inches)
a	0.765	0.465
b	0.200	0.196
c	0.780	0.910
d	0.230	0.406

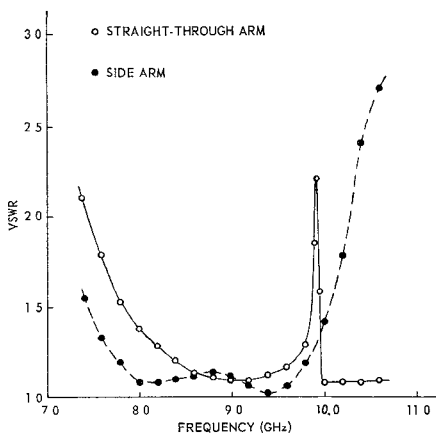


Fig. 2. VSWR versus frequency for Model 1 of the dual-mode coupler.

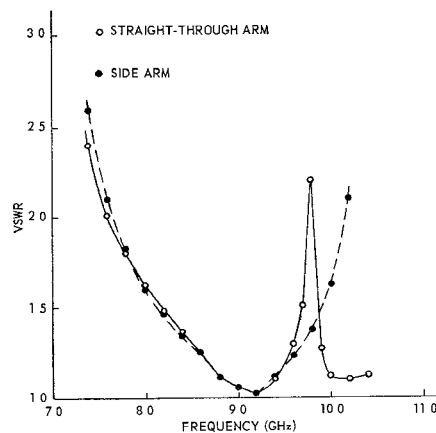


Fig. 3. VSWR versus frequency for Model 2 of the dual-mode coupler.

Two models were designed and tested. Their configuration including dimensional information is shown in Fig. 1; specific dimensions of the irises are given in Table I. The smaller resonant iris in Model 1 yields a wider bandwidth; however, it reduces the power-handling capabilities of the side arm.

Both models were tested for VSWR, power handling capabilities, and isolation. The VSWR versus frequency characteristics are shown in Figs. 2 and 3. Both couplers were tested at atmospheric pressure with a pulsed power source having a pulse length of 1.0  $\mu$ s,

a pulse repetition frequency of 600 Hz, and a frequency coverage from 8.5 to 9.6 GHz. The straight-through arm of both models handled over 250 kW peak; the side arm handled over 125 kW peak in Model 1 and over 250 kW peak in Model 2. In both couplers, the isolation between the rectangular arms exceeded 50 dB over the test frequency bands of 8.2 to 9.8 GHz and 8.4 to 9.6 GHz for Models 1 and 2, respectively.

The performance reported here does not necessarily represent the ultimate limits for this type of coupler. It is felt that with changes

in the taper and with a different shape for the resonant iris the coupler would perform well over a broader frequency band.

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#### REFERENCES

- [1] F. E. Ehlers, "Lowest mode in the waveguide transitions," in *Microwave Transmission Circuits*, G. L. Ragan, Ed., M.I.T. Radiation Lab. Ser., vol. 9. New York: McGraw-Hill, 1948, p. 369.
- [2] D. J. LeVine and W. Sichak, "Dual-mode horn feed for microwave multiplexing," *Electronics*, pp. 162-164, September 1954.
- [3] S. G. Komlos, P. Foldes, and K. Jasinski, "Feed system for clockwise and counterclockwise circular polarization," *IRE Trans. Antennas and Propagation (Communications)*, vol. AP-9, pp. 577-578, November 1961.
- [4] J. Y. Wong, "A dual polarization feed horn for a parabolic reflector," *Microwave J.*, vol. 5, pp. 188-191, September 1962.
- [5] W. A. Cumming, "A dual-polarized line source for use at S-band," *Microwave J.*, vol. 6, pp. 81-87, January 1963.
- [6] M. W. Long, "A 35,000-Mc multiple polarization radar system," presented at the Conf. on Millimeter Wave Research and Applications, Office of Naval Research, Washington, D.C., September 1953.
- [7] H. D. Ivey and M. W. Long, "Polarization characteristics of radar targets," Georgia Institute of Technology, Atlanta, Quart. Rept. 1, Contract DA-36-039-sc-56761, August 1954. (AD 64958)
- [8] C. H. Currie, R. D. Hayes, H. D. Ivey, and M. W. Long, "Polarization characteristics of radar targets," Georgia Institute of Technology, Atlanta, Final Rept., Contract DA-36-039-sc-56761, March 1955. (AD 55124)
- [9] A. J. Simmons, "3-millimeter waveguide components," TRG, Inc., East Boston, Mass., Final Rept., Contract DA-36-039-sc-88979, August 1964.
- [10] A. J. Simmons and O. M. Giddings, "Ferrite Devices for the 3-mm band," *WESCON Rec.*, pp. 25-28, August 1964.
- [11] A. J. Simmons, "Faraday rotation devices for the 3-mm band," *Microwave J.*, vol. 8, pp. 65-69, April 1965.
- [12] B. F. LaPage, "The West-Ford antenna system," M.I.T. Lincoln Lab., Lexington, Mass., Tech. Rept. 338, Contract AF 19(628)-500, December 6, 1963. (AD 438879)
- [13] R. C. Johnson, "Design of linear double tapers in rectangular waveguides," *IRE Trans. Microwave Theory and Techniques*, vol. MTT-7, pp. 374-378, July 1959.

#### Comment on "Isolation of Lossy Transmission Line Hybrid Circuits"

I should like to call attention to several errors appearing in the above correspondence.<sup>1</sup> These errors are presumably typographical, and indeed do not affect the calculated isolation values. However, they could impair the utility of the correspondence to the reader wishing to extend the analysis to calculate the remaining properties of the two hybrid types. The errors are listed in the following.

Equation (13) should read

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<sup>1</sup> R. M. Kurzrok, *IEEE Trans. Microwave Theory and Techniques (Correspondence)*, vol. MTT-15, pp. 127-128, February 1967.